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September 28, 2001

ATTORNEY'S DOCKET NO. 97-064B

Box Patent Application

Assistant Commissioner for Patents

Washington, DC 20231

Sir:

Please file the divisional patent application of *Matthew G. Kistner and Jeff D. Will* for *Combined Superplastic Forming and Adhesive Bonding*, which is based upon U.S. Patent Application 09/556,752, filed April 21, 2000, and U.S. Provisional Patent Application 60/130,869, filed April 23, 1999. To support the filing, please find enclosed:

The application including twenty-seven (27) written pages and two (2) sheets of drawing;

A copy of the original declaration from 09/556,752; and

A postcard for you to acknowledge receipt.

The filing fee is calculated as follows:

CLAIMS AS FILED				
FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
TOTAL CLAIMS	6	0	\$18.00	\$0.00
INDEPENDENT CLAIMS	2	0	\$80.00	\$0.00
BASIC FEE				\$710.00
TOTAL FILING FEE				\$710.00

Please charge Deposit Account No. 02-2960 in the amount of \$710.00. The Commissioner is authorized to charge any additional fees under 37 CFR § 1.16 or § 1.17 that may be required at any time during the prosecution of this application

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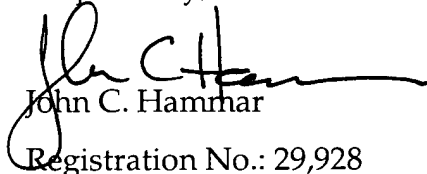
without specific authorization, or credit any overpayment to Deposit Account 02-2960. Any necessary duplicate copies of this letter are enclosed.

The parent application was assigned of record to The Boeing Company at Reel 011176, Frame 0254.

Please address future correspondence to:

John C. Hammar  
The Boeing Company  
PO BOX 3707, MC 13-08  
Seattle, WA 98124-2707

Respectfully,

  
John C. Hammar

Registration No.: 29,928

206-544-1059

Enclosures: application  
declaration from 09/556,752  
return postcard